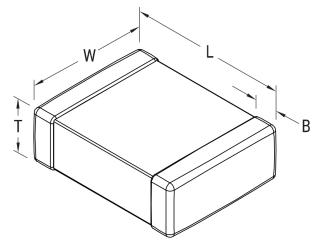


CDR03BX223BKSM-T&R

Aliases (C1808P223K1XMH7189)

SMD Mil PRF55681, Ceramic, 0.022 uF, 10%, 100 VDC, BX, M (1%/1000 Hrs), 1808



Click here for the 3D model.

Dimensions	
Chip Size	1808
L	4.57mm +1.02/-0.38mm (0.18 in +0.04/-0.015 in)
W	2.03mm +0.76/-0.38mm (0.08 in +0.03/-0.015 in)
Т	1.295mm +1.115/-0.735mm (0.051 in +0.044/-0.029 in)
В	0.51mm +0.63/-0.25mm (0.02 in +0.025/-0.01 in)

Packaging Specifications		
Packaging	T&R, 178mm, Plastic Tape	
Packaging Quantity	2500	

General Information	
Series	SMD Mil PRF55681
Style	SMD Chip
RoHS	No
Prop 65	WARNING: Cancer and reproductive harm - http://www.p65warnings.ca.gov.
SCIP Number	de44f0ec-7e7c-4120-b42e-f63f667919b6
Termination	Lead (SnPb)
Failure Rate	M (1%/1000 Hrs)
Testing and Reliability	MIL-PRF-55681
Qualifications	MIL-PRF-55681
AEC-Q200	No
Miscellaneous	Termination Description: SolderCoat 60-40.
Shelf Life	78 Weeks
MSL	1

Specifications	
Capacitance	0.022 uF
Capacitance Tolerance	10%
Voltage DC	100 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	BX

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and we specifically disclaim - any warranty concerning suitability for a specific customer application or use. This Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by us with reference to the use of our products is given gratis, and we assume no obligation or liability for the advice given or results obtained.

单击下面可查看定价,库存,交付和生命周期等信息

>>KEMET(基美)